



AMENDMENTS TO THE SPECIFICATION

Please replace the paragraph beginning at line 14 of page 6 with the following paragraph:

Another wafer transfer mechanism that may also be employed in the present invention is disclosed in commonly-assigned U.S. Application No. 09/887,202 (unassigned), filed on June 21, 2001, entitled "Magnetically Coupled Linear Servo-Drive Mechanism," attorney docket no. 50544.00010, by Thomas Pratt, Scott McClelland, Craig L. Stevens, and Kerry Hopkins. The just mentioned application is incorporated herein by reference in its entirety. It is to be noted that the present invention is not limited to wafer transfer mechanisms of the type disclosed in the just mentioned application or the present disclosure. For example, wafer transfer between a load lock 120 and process module 130 may also be performed using a vacuum robot located either inside the load lock 120 or process module 130.